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INFORMATION	Applicant: Katsuyuki		AUG 1 0 2009	2 AUG 10 % &
DISCLOSURE	Ser.No.: 10/588 686	Filed: August	2006	13
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	Group: 1795	Date: August	4, 260	PADISABO
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		FOREIGN E	PATENT DOCUMENTS		
Examiner Initials*	No.	Country Code - Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Trans.
/EW/	AA	JP 2002-508452	03-19-2002	*	includes English language abstract
	AB	JP 2002-506927	03-05-2002		includes English language abstract
	AC	JP 63-310989	12-19-1988	Shimamura, et al.	includes English language abstract
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	AE	JP 08-156176	06-18-1996	Kataoka, et	includes English language abstract
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		NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	No.	(Include Author, Title, Date, Pages, Etc.)			
	AG	Japanese language Office Action in a counterpart foreign			
/EW/		application dated July 6, 2009 (4 sheets)			
	AH	Japanese language Office Action in a counterpart foreign			
		application dated May 8, 2009 (4 sheets)			
	AI	Japanese language Office Action in a counterpart foreign			
	1 1	application dated April 9, 2009 (3 sheets)			
	AJ	"Voltammetric and morphological characterization of copper			
		electrodeposition from non-cyanide electrolyte'', M.R.H. DE			
		ALMEIDA, et al., Journal of Applied Electrochemistry, Vol.			
$\perp \Psi$		32, pp. 763-773 (2002)			
EXAMINER	SIGNAT	URE /Edna Wong/ DATE CONSIDERED 04/01/2010			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

	(Modified)	